

Product Change Notification

Change Title	DDR4 product change notice for Samsung 2400 512Mx16 B die IC solution	Date	2021/11/12	PCN No	21111001
PCN level:	Major				
Models :	Innodisk DDR4 Samsung 2400 512xMx16 B die IC DRAM Module products				
Category:	Hardware - IC				

Key Characteristics of the Change:

Based on supplier's product condition, Innodisk hereby to announce the product plan change for all of DDR4 Samsung 2400 512Mx16 B die IC DRAM Modules.

Description:

Innodisk is going to process DDR4 Samsung 2400 512Mx16 B die IC product termination and running change to DDR4 Samsung 2666 512Mx16 C die IC product series. Include products below: DDR4 512Mx16 4GB / 8GB SODIMM & UDIMM Modules.

Key Milestone Dates

Last Purchase Date: **2022/02/15**

Last Shipment Date: **2022/05/15**

*Milestone dates are subject to change based on business and operational conditions.

Affected Model Table

#	Current Part Number	New Part Number
1	M4US-4GSX1CRG-B	M4UI-4GSX1CRG-C
2	M4SS-4GSXZC0J-B	M4SI-4GSXZCSJ-C
3	M4SS-8GSX8CRG-B	M4SI-8GSX8CRG-C
4	M4US-4GSX1C0J-B	M4UI-4GSX1CSJ-C
5	M4SS-4GSXZCRG-B	M4SI-4GSXZCRG-C
6	M4US-8GSX2C0J-B	M4UI-8GSX2CSJ-C
7	M4US-8GSX2CRG-B	M4UI-8GSX2CRG-C
8	M4SS-8GSX8CRG-B	M4SI-8GSX8CRG-C

Notes:

1. For the alternative samples, DDR4 Samsung 512Mx16 C die IC solutions are currently available.
2. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones. Innodisk apologizes for any inconvenience caused by this and appreciate your understanding.
3. Innodisk promises that new items deliver quality and reliability are JEDEC compliant. If there is any further inquiry of our products or product specification, please contact your Innodisk contact sales person for support.

DRAM BU Vice President
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Samson Chang